



Product/Process Change Notice - PCN 13_0257 Rev. A

Analog Devices, Inc. Three Technology Way Norwood, Massachusetts 02062-9106

******* ATTENTION: THIS PCN IS BEING CANCELLED! *******

This notice is to inform you of a change that will be made to certain ADI products (see Material Report). Any issues with this PCN or requirements to qualify the change (additional data or samples) must be sent to ADI within 30 days of publication date. ADI contact information is listed below.

Note: Revised fields are indicated by a red field name. See Appendix B for revision history.

PCN Title: Assembly Transfer of Select 6x6mm Stacked-Die LFCSP Products to STATS ChipPAC China

Publication Date: 08-Jul-2014

Effectivity Date: Effective upon publication.

Revision Description:

The parts are not transferring to STATS ChipPAC China therefore, this PCN is being cancelled.

Description Of Change

ADI is transferring to subcontractor STATS ChipPAC China for the assembly manufacturing of select 6x6mm stacked-die LFCSP products. The package outline dimensions and BOM of each product will be maintained.

Reason For Change

ADI is transferring to STATS ChipPAC China due to the closure of STATS ChipPAC Malaysia at the end of 2014.

ADI's assembly subcontractors manufacture products using Analog Devices specified manufacturing flows, materials, process controls and monitors, ensuring the same level of quality and reliability on products they receive from the new site.

Impact of the change (positive or negative) on fit, form, function & reliability

The transfer will have no impact on the form, fit, function and reliability of the devices.

Product Identification *(this section will describe how to identify the changed material)*

The parts that will be assembled after the transfer will be identified by assembly lot and the country of origin.

Summary of Supporting Information

Qualification will be performed per ADI0012, Procedure for Qualification of New or Revised Processes. See attached Qualification Plan Summary.

Supporting Documents

Attachment 1: Type: Qualification Plan

ADI_PCN_13_0257_Rev_A_Reliability Qualification Plan.pdf

Attachment 2: Type: Detailed Change Description

ADI_PCN_13_0257_Rev_A_BOM.pptx

For questions on this PCN, send email to the regional contacts below or contact your local ADI sales representative

Americas: PCN_Americas@analog.com

Europe: PCN_Europe@analog.com

Japan: PCN_Japan@analog.com

Rest of Asia: PCN_ROA@analog.com

Appendix A - Affected ADI Models

Existing Parts - Product Family / Model Number (4)

ADAS3022 / ADAS3022BCPZ	ADAS3022 / ADAS3022BCPZ-RL7	ADAS3023 / ADAS3023BCPZ	ADAS3023 / ADAS3023BCPZ-RL7	
-------------------------	-----------------------------	-------------------------	-----------------------------	--

Appendix B - Revision History

Rev	Publish Date	Effectivity Date	Rev Description
Rev. -	12-Nov-2013	18-May-2014	Initial Release
Rev. A	08-Jul-2014	08-Jul-2014	The parts are not transferring to STATS ChipPAC China therefore, this PCN is being cancelled.

Analog Devices, Inc.

DocId:2948 Parent DocId:None Layout Rev:7